

FE50MSIR FE50MSNR



DC-50 Fiber Optic SMI Transceiver

Preliminary Datasheet



DESCRIPTION

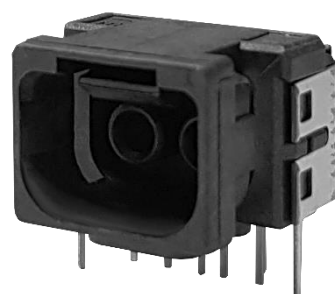
Firecomms DC-50 MBd SMI transceiver consists of separate transmitter and receiver channels enabling duplex transmission over duplex plastic optic fiber cable. The optical transmitter is a visible red 650 nm Resonant Cavity Light Emitting Diode (RCLED) with integrated driver IC. The receiver is a fully integrated silicon IC with a front-end light sensing dual-differential-photodiode and a push-pull TTL/LVTTL compatible CMOS output stage. They are housed in an SMI connector providing a latched plug connection. They can transmit and receive DC light levels or low speed data for example, pulse width modulated (PWM) signals at speeds from DC up to 50 Mbps (25 MHz) over plastic optic fiber and operate over the industrial temperature range -40 °C to +85 °C (ambient air). The device can operate from 5 V (TTL) or 3.3 V (LVTTL) DC power supply rails. The Tx and Rx can be supplied from different supply rails, but it is recommended that they use the same supply. The transmitter has a non-inverting optical output. The receiver is available in inverting and non-inverting options.

AVAILABLE OPTIONS

Table 1

ORDERING INFORMATION / PART NUMBERS

DC-50 Mb SMI Non-Inverting Tx, Inverting Rx	FE50MSIR
DC-50 Mb SMI Non-Inverting Tx, Non-Inverting Rx	FE50MSNR



FEATURES

- Visible RCLED at red wavelength (650 nm)
- Optimised for data rates from DC to 50 MBd
- Industrial temperature range -40 °C to +85 °C
- Push Pull TTL Compatible CMOS output
- Dual power supply 5 V or 3.3 V
- RoHS compliant
- Conductive plastic body with metal shield ideal for safe discharge of static charge from cables or operator handling
- Ultra-low pulse width distortion suitable for burst mode data transmission
- High EMI/EMC immunity

APPLICATIONS

Table 2
APPLICATIONS

Application	Medical, instrument control, patient safety. Automation and Industrial Control. Serial Communications. Voltage Isolation. High EMI/EMC environments.
Standard	Serial RS232, RS485, Modbus, PROFIBUS
Distance	50 meters Step Index POF ^[1]
Speed	DC to 50 MBd

Note: 1. Depending on the installation conditions

SPECIFICATIONS

Table 3
TRANSCEIVER PIN DESCRIPTION

Pin	Name	Symbol
Transmitter		
1	EMI SHIELD ^[1]	GND
2	DATA INPUT (TTL)	V _{in}
3	GROUND	GND
4	GROUND	GND
5	VCC (5/3.3 V) ^[2]	V _{cc}
6	VCC (5/3.3 V)	V _{cc}
Receiver		
7	VCC (5/3.3 V)	V _{cc}
8	VCC (5/3.3 V)	V _{cc}
9	GROUND	GND
10	DATA OUTPUT	V _o
11	NO CONNECT	NC
12	EMI SHIELD ^[1]	GND

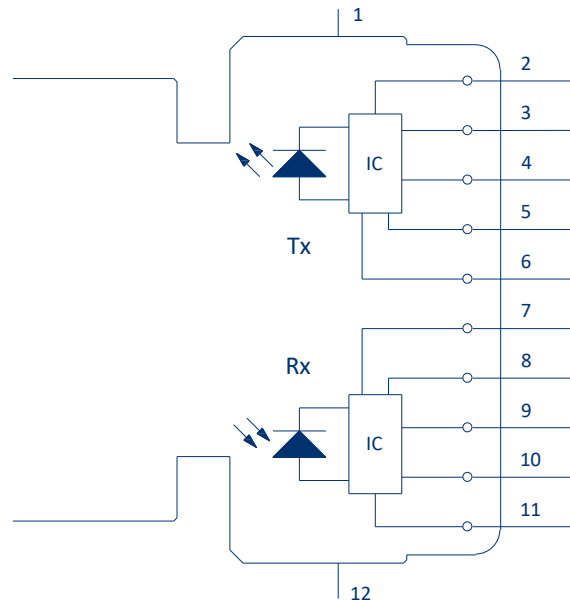


FIGURE 1
Transceiver pin-out, top view

Note:

1. EMI Shield ground pins must be connected to the signal ground plane on the PCB. This is important to prevent cross-talk between Tx and Rx and also to shield the internal fiber optic transceivers (FOTs) from external EMI/EMC and ESD
2. For reduced power consumption and maximum operating lifetime, it is highly recommended to use a 3.3 V supply
3. It is recommended to use the same supply for both Tx and Rx

RECOMMENDED APPLICATION CIRCUIT

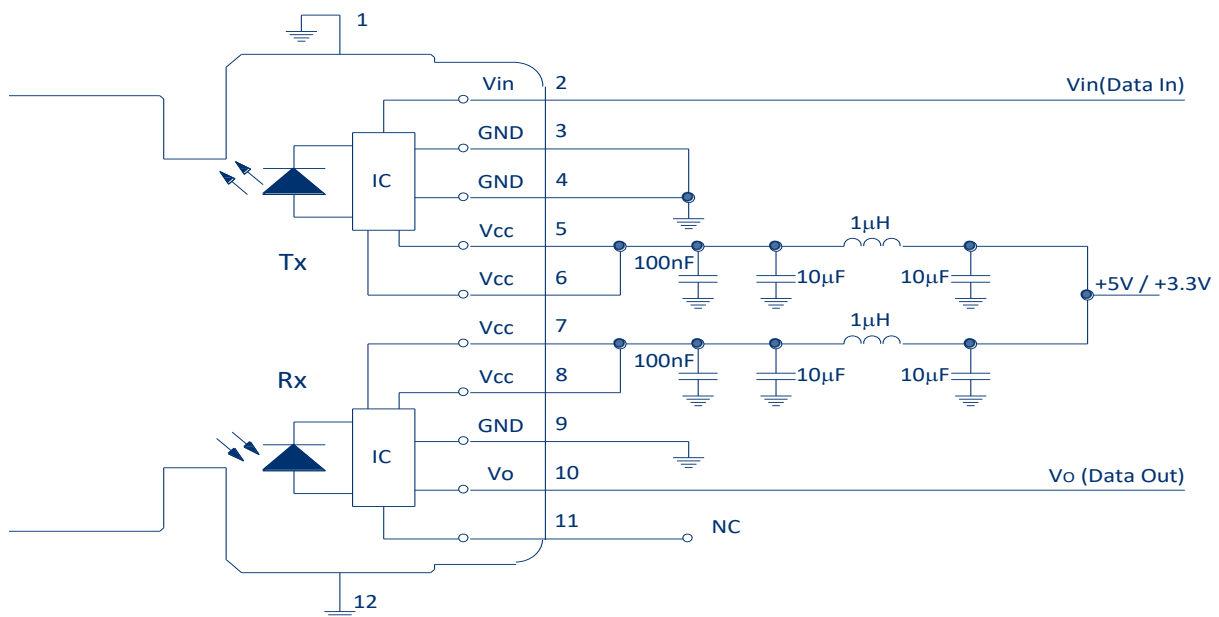


FIGURE 2
Recommended application circuit

GENERAL OPERATION

Inverting Part FE50MSIR

FE50MSIR consists of a non-inverting transmitter and inverting receiver.

Non-Inverting Transmitter

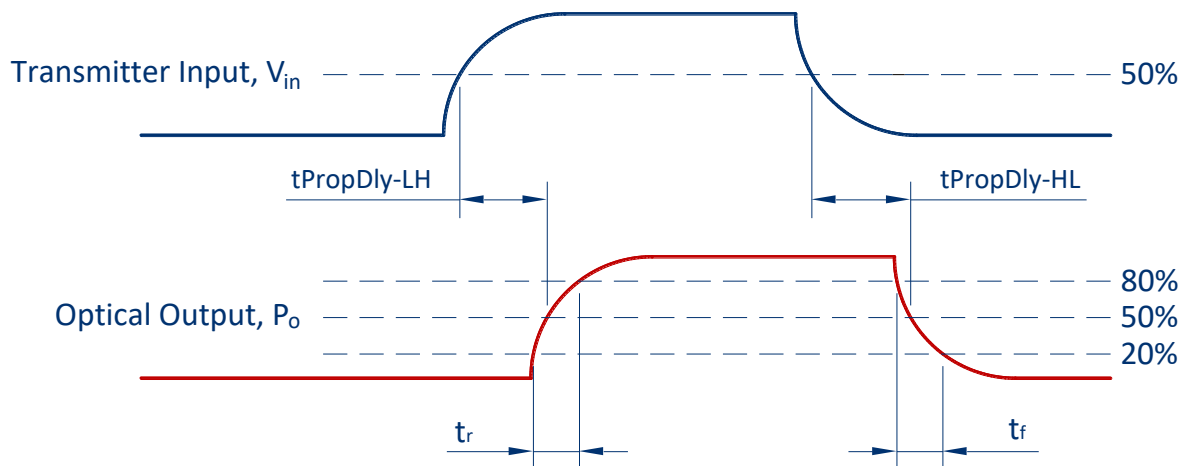


FIGURE 3
FE50MSIR Transmitter Propagation Delay and rise/fall time definitions

Inverting Receiver

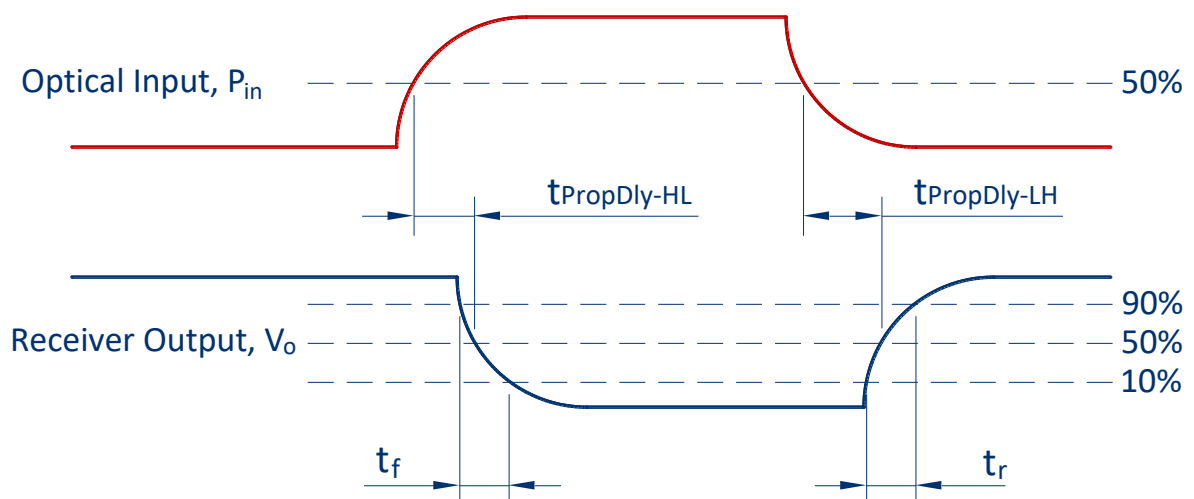


FIGURE 4
FE50MSIR Receiver Propagation Delay and rise/fall time definitions

Inverting Part FE50MSIR (Continued)

FE50MSIR operation during power up, power down or power reset is illustrated below in figures 5, 6 & 7.

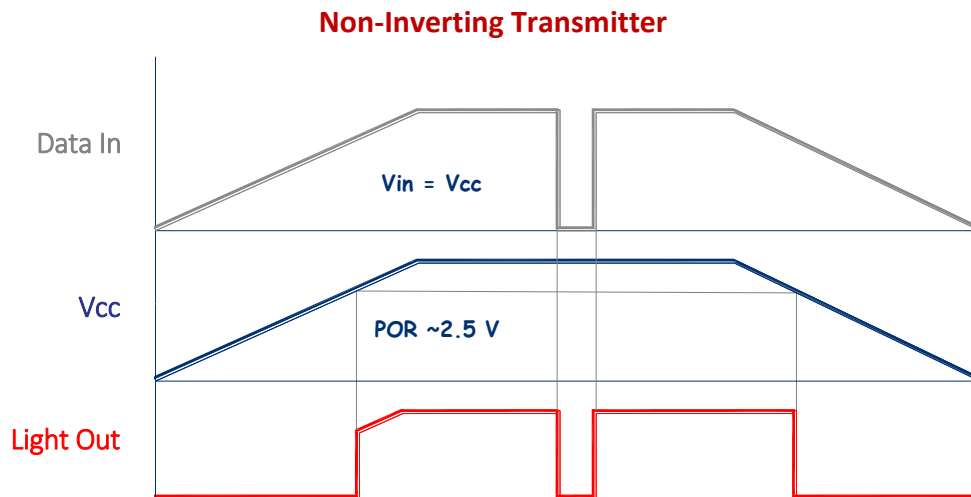


FIGURE 5
FE50MSIR Non-Inverting Tx operation during power cycling with input logic high

During power up as Vcc rises to approximately 2.5 V, there is no light output. Once Vcc reaches 2.5 V, the transmitter will output correctly based on the input voltage level. In Figure 5 above the input logic level is high during power up, so the transmitter will output light.

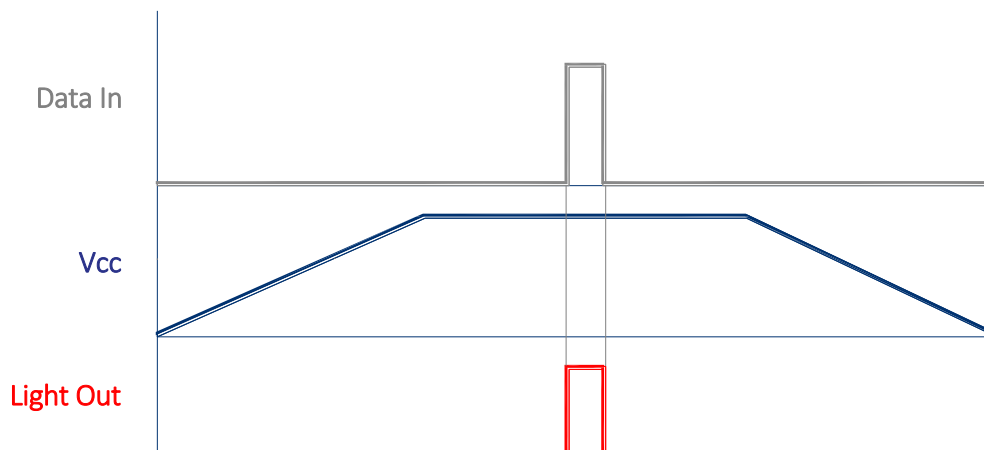


FIGURE 6
FE50MSIR Non-Inverting Tx operation during power cycling with input logic low

In Figure 6 the input logic level is low during power up, so the transmitter outputs no light.

Inverting Part FE50MSIR (Continued)

Inverting Receiver

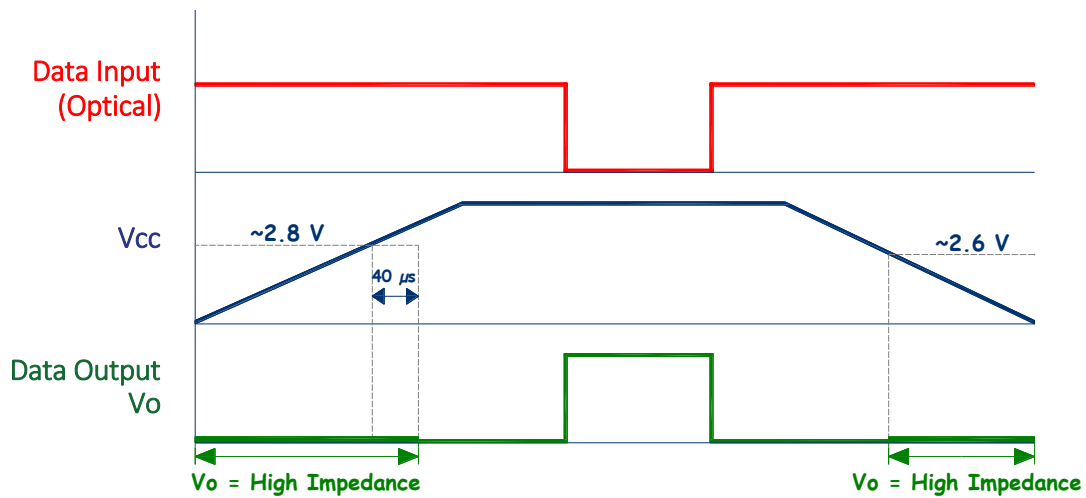


FIGURE 7
FE50MSIR Inverting Rx operation during power cycling

During power up as Vcc rises to approximately 2.8 V the output Vo is in a high impedance state. Within 40 μs of Vcc reaching 2.8 V the output Vo will change to the correct logic state which in the diagram above is logic low as there is light present and the output is inverted relative to the light input. On power down once Vcc drops below approximately 2.6 V then Vo changes immediately to a high impedance state.

Non-Inverting Part FE50MSNR

FE50MSNR consists of a non-inverting transmitter and non-inverting receiver.

Non-Inverting Transmitter

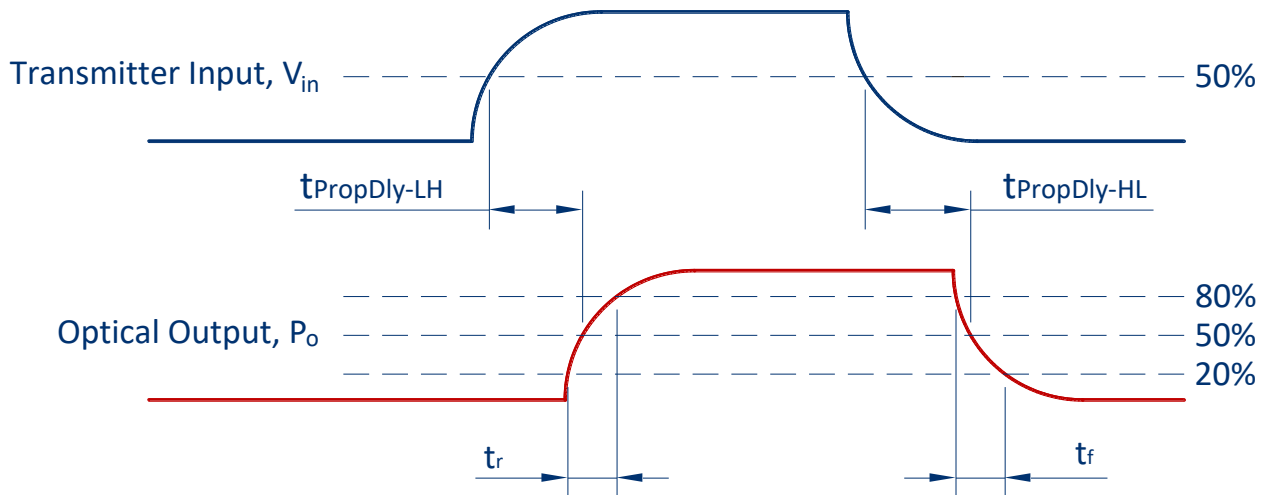


FIGURE 8
FE50MSNR Transmitter Propagation Delay and rise/fall time definitions

Non-Inverting Receiver

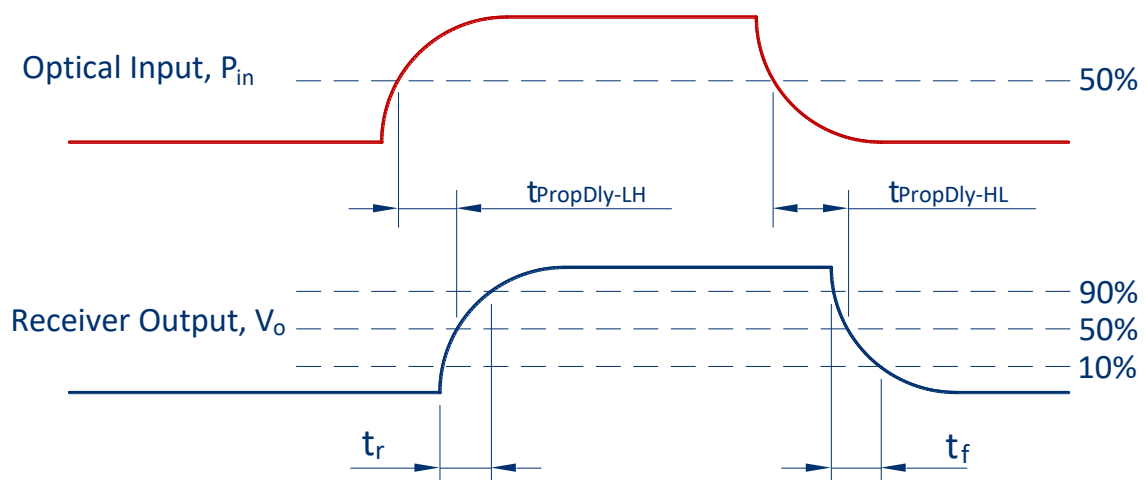


FIGURE 9
FE50MSNR Receiver Propagation Delay and rise/fall time definitions for a non-inverting V_o output

Non-Inverting Part FE50MSNR (Continued)

FE50MSNR operation during power up, power down or power reset is illustrated below in figures 10, 11 & 12.

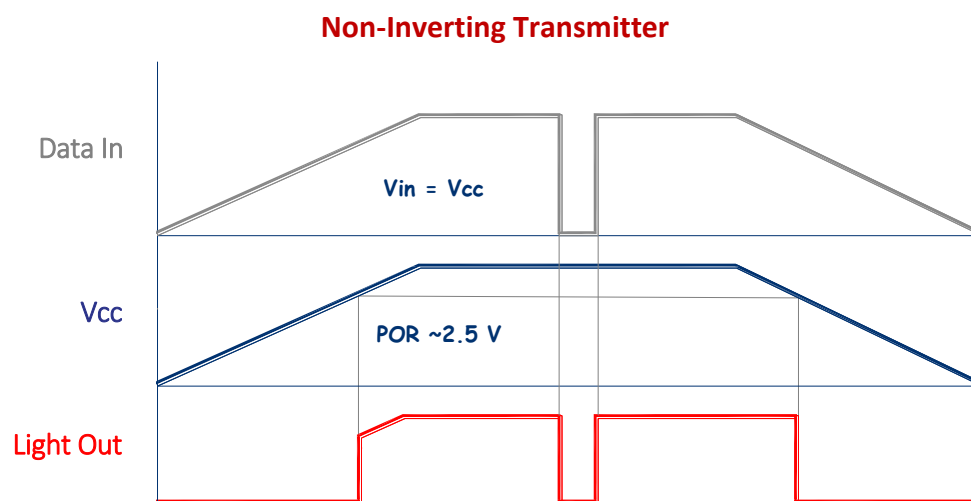


FIGURE 10
FE50MSNR Non-Inverting Tx operation during power cycling with input logic high

During power up as Vcc rises to approximately 2.5 V, there is no light output. Once Vcc reaches 2.5 V, the transmitter will output light correctly based on the input voltage level. In Figure 10 above the input logic level is high during power up, so the transmitter will output light.

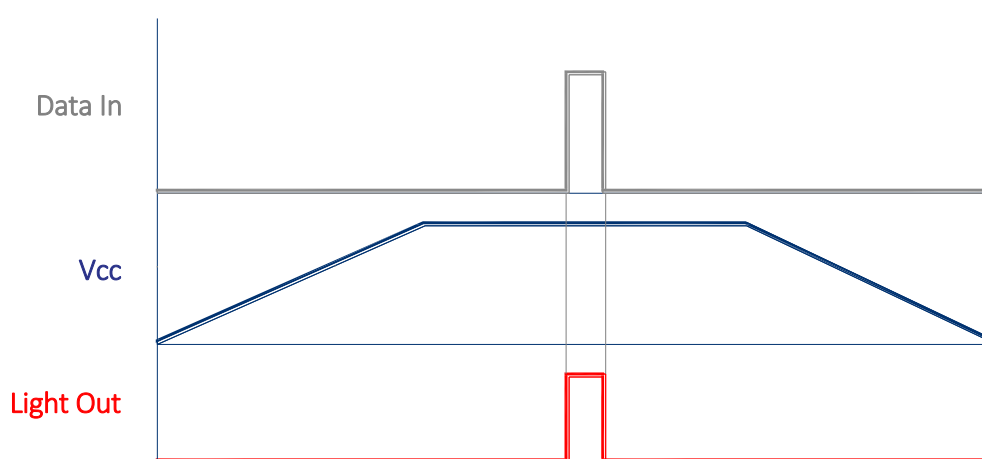


FIGURE 11
FE50MSNR Non-Inverting Tx operation during power cycling with input logic low

In Figure 11 the input logic level is low during power up, so the transmitter outputs no light.

Non-Inverting Part FE50MSNR (Continued)

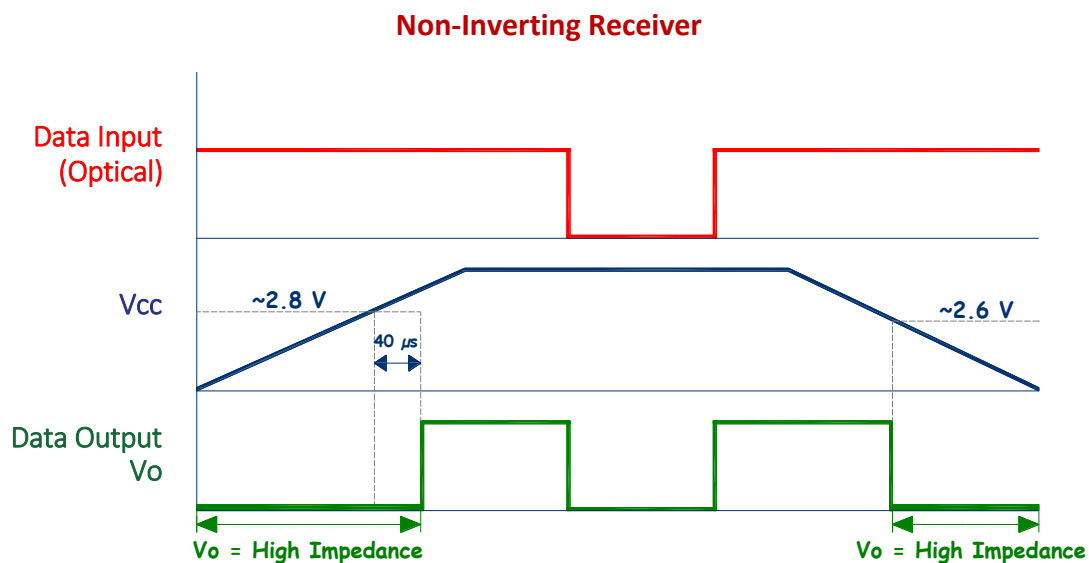


FIGURE 12
FE50MSNR Non- Inverting Rx operation during power cycling

During power up as Vcc rises to approximately 2.8 V the output Vo is in a high impedance state. Within 40 μs of Vcc reaching 2.8 V the output Vo will change to the correct logic state which in the diagram above is logic high as there is light present and the output is non-inverting. On power down once Vcc drops below approximately 2.6 V then Vo changes immediately to a high impedance state.

SPECIFICATIONS

Table 4
REGULATORY COMPLIANCE

Parameter	Symbol	Standard	Level
Electrostatic Discharge, Human Body Model (contact ESD)	HBM	JEDEC JS-001	Level 2 (2kV to < 4kV)
Storage Compliance	MSL	J-STD-020E	2a (4-week floor life)
Restriction of Hazardous Substances Directive	RoHS	Directive 2011/65/EU Incl. Amendment 2015/863	Certified compliant
Eye Safety		IEC 60825-1	LED Class 1

Table 5
ABSOLUTE MAXIMUM RATINGS

These are the absolute maximum ratings at or beyond which the product can be expected to be damaged

Notes:

1. 260 °C for 10 seconds, one time only, at least 2.2 mm away from lead root
2. Applying conditions above absolute maximum ratings is destructive to the device. Functional operation of the device at conditions between maximum operating conditions (5.5 V) and absolute maximum ratings is not implied. Extended exposure to stresses above recommended operating conditions will affect device reliability
3. V_{IN} should not exceed V_{CC} . This is very important during the power-up sequence. If $V_{IN} > V_{CC}$, then the driver IC power from V_{IN} to power-up. This is an uncontrolled logic state and must be avoided

Parameter	Symbol	Minimum	Maximum	Unit
Storage Temperature	T_{stg}	-40	+85	°C
Operating Temperature	T_{op}	-40	+85	°C
Soldering Temperature ^[1]	T_{sld}		+260	°C
Supply Voltage (Tx, Rx) ^[2]	V_{CC}	-0.5	+7	V
Tx Input Voltage (Data in) ^[3]	V_{IN}	-0.5	$V_{CC} + 0.5$	V
Rx Output Current	I_O	-16	+16	mA

SPECIFICATIONS

Table 6
TRANSMITTER ELECTRICAL AND OPTICAL CHARACTERISTICS

Test Conditions:

1. Test data was validated over the full temperature range of -40 °C to +85 °C, and over both power supply rail options of 5 V and 3.3 V ± 5%. Typical data out is at 25 °C, with 50 Mbps PRBS data and 3.3 V Supply
2. Output power levels are for peak (not average) optical output levels. For 50% duty cycle data, peak optical power is twice the average optical power. Optical power is measured when coupled into 0.5 m of a 1 mm diameter 0.5 NA POF and a large area detector.
3. Electrical input pulse width is determined at 1.5 V and dV/dt between 1 V and 2 V shall not be less than 1 V/ns.
4. Emission Wavelength (centroid) $\lambda_c = \sum P_i \lambda_i / \sum P_i$. (Ref: EIA/TIA std. FOTP-127/6.1, 1991)
5. Spectral Width Root Mean Squared (RMS) $\lambda_{RMS} = (\sum P_i (\lambda_c - \lambda_i)^2 / \sum P_i)^{1/2}$. (Ref: EIA/TIA std. FOTP-127/6.3, 1991)
6. Wake Up Delay is the time from valid power up to valid data output, at 5 V or 3.3 V +/-5%, with input data at 50% duty cycle

Parameter	Symbol	Min	Typical	Max	Unit	Test Condition
Supply Current	I _{CC}		16.5 @ 3.3 V 17.5 @ 5 V	27	mA	[1]
Input Voltage - Low	V _{IL}	-0.3		0.8	V	[1]
Input Voltage - High	V _{IH}	2		V _{CC} + 0.25	V	[1]
Data Input Capacitance	C _{in}			7	pF	
Data Input Resistance	R _{in}	10			MΩ	
Output Power	P _{High}	-9		-1	dBm	[1,2]
Emission Wavelength (centroid)	λ_c	640	650	680	nm	[4]
Spectral Width (RMS)	λ_{RMS}			30	nm	[5]
Optical Rise time (20% - 80%)	t _r		1.6	5	ns	[1]
Optical Fall time (20% - 80%)	t _f		1.3	2	ns	[1]
Propagation Delay Low-to-High	t _{PropDly_LH}	13	22	30	ns	[1], Figure 3
Propagation Delay High-to-Low	t _{PropDly_HL}	13	22	30	ns	[1], Figure 3
Tx Pulse Width Distortion	PWD	-3		+3	ns	[1,4]
Wake Up Delay (power up)	t _{power-on}		20		μs	[6]

SPECIFICATIONS

Table 7
RECEIVER ELECTRICAL AND OPTICAL CHARACTERISTICS

Test Conditions:

1. Wake up Delay is the delay from $V_{CC} > 2.75\text{ V}$ to when the output will respond correctly to optical input. Output is held in tristate before this time.
2. Test data was validated using a transmitter with an emission wavelength between 635 and 680 nm with a 5 ns rise and fall time, over the full temperature range of $-40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$, over both supply rail voltage options of 5 V and $3.3\text{ V} \pm 5\%$, and over the input optical received power as specified by P_H and P_L . Input power levels are for peak (not average) optical input levels. For 50 % duty cycle data, peak optical power is twice the average optical power. Data referred to as typical are rated at $+25\text{ }^{\circ}\text{C}$
3. Optical signal from the recommended Transmitter circuit.
4. Testing in the recommended receiver circuit ($R_L = 50\text{ k}\Omega$, $C_L(\text{total}) = 15\text{ pF}$)
5. PWD for Optical Input of 50 MBd, NRZ 2⁷-1 (PRBS7) data, resulting in a $BER \leq 10^{-9}$
6. PWD for 1st to 3rd pulse is characterized with minimum Optical Input pulse width of 20 ns, with the 1st pulse being the worst case. For pulses $> 20\text{ ns}$ the PWD will be less. If data rate $< 1\text{ MBd}$, then the pulse width distortion = PWD 1st to 3rd pulse.
7. The performance of the receiver as given in Table 7 has been characterized for transmitters operating between 635 and 680 nm. The receiver will nevertheless respond to optical sources operating from the visible to near infra-red regions although the precise performance may differ from that given in Table 7 depending upon the precise wavelength and rise/fall time characteristics of the optical source used.

Parameter	Symbol	Min	Typical	Max	Unit	Test Condition
Supply Current	I_{CC}		20	25	mA	[2,3,4]
Wake Up Delay (power up)	$t_{\text{power-on}}$		40		μs	[1]
High Level Output Voltage	V_{OH}	$V_{CC} - 0.05$		V_{CC}	V	$I_{OH\text{-max}} = 40\text{ }\mu\text{A}$, [2]
Low Level Output Voltage	V_{OL}	0		0.05	V	$I_{OL\text{-max}} = 1.6\text{ mA}$, [2]
Optical Power High	P_H	-22		-1	dBm	[2,3]
Optical Power Low	P_L			-40	dBm	[2,3]
Data Rate		DC		50	MBd	Min UI = 20 ns, Max f = 25 MHz
Output Rise Time (10% - 90%)	t_r			6	ns	[2,3,4]
Output Fall Time (10% - 90%)	t_f			6	ns	[2,3,4]
Pulse Width Distortion for PH range -20 to + 2 dBm	PWD	-4		4	ns	[2,3,4,5]
Pulse Width Distortion for PH range -20 to -22 dBm	PWD	-6		6	ns	[2,3,4,5]
Pulse Width Distortion 1st to 3rd pulse	PWD_{init}	-7		14	ns	[2,3,4,5,6]
Propagation Delay	$t_{\text{PropDly-HL}}$			50	ns	[2,3,4]
	$t_{\text{PropDly-LH}}$			50	ns	[2,3,4]

MECHANICAL DATA

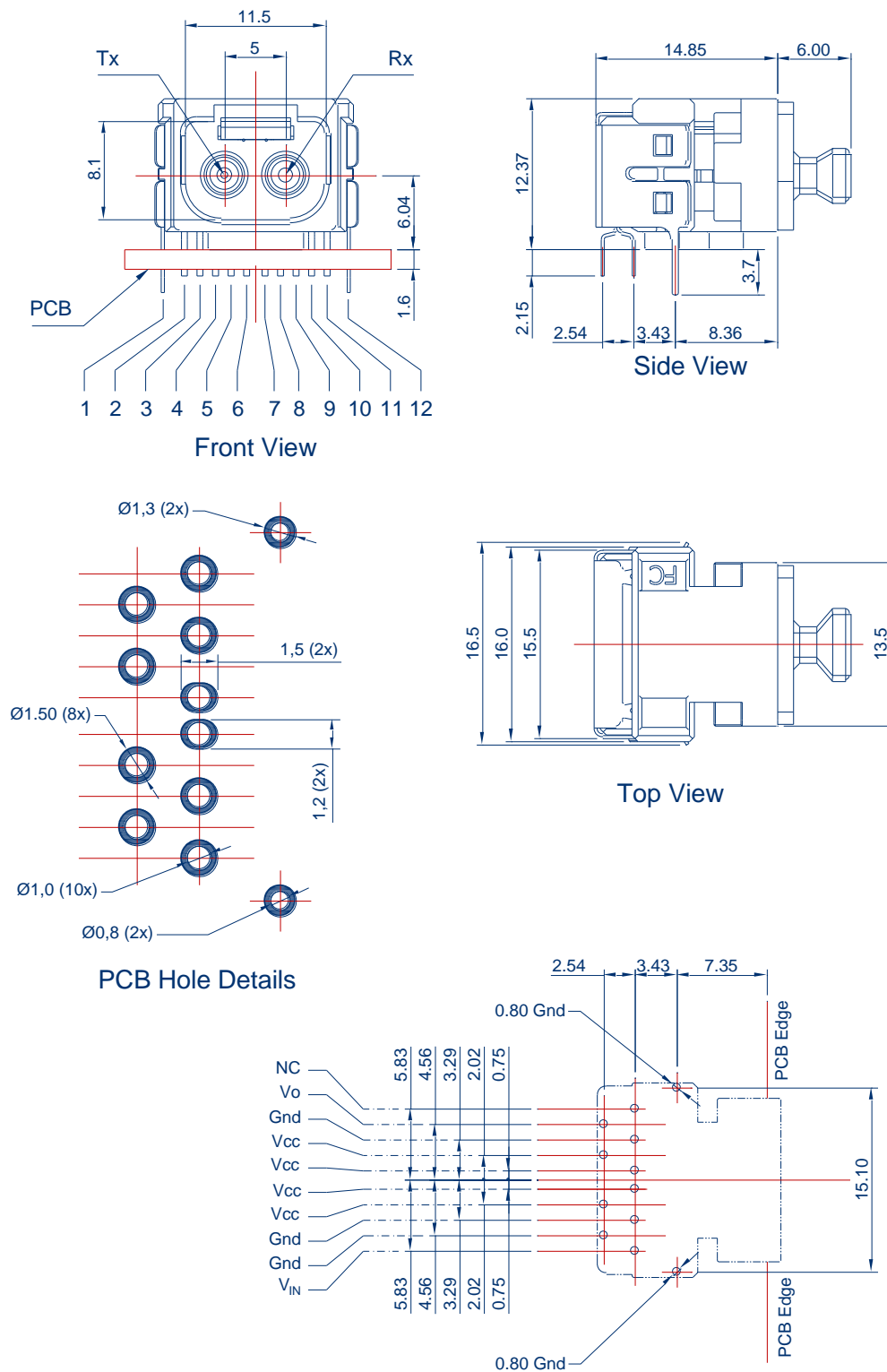


FIGURE 13
Mechanical dimensions of the product, and PCB footprint, which is a top view
General dimensional tolerance is ± 0.2 mm

NOTE: For PCB layout extra care is required with pin 6 and pin 7. On the PCB top and bottom metal they require a non-circular pad. The VIA's are standard plated circular through holes, however, the VIA top and bottom solder pad areas are non-circular 1.2 mm wide and 1.5 mm long oval shapes.

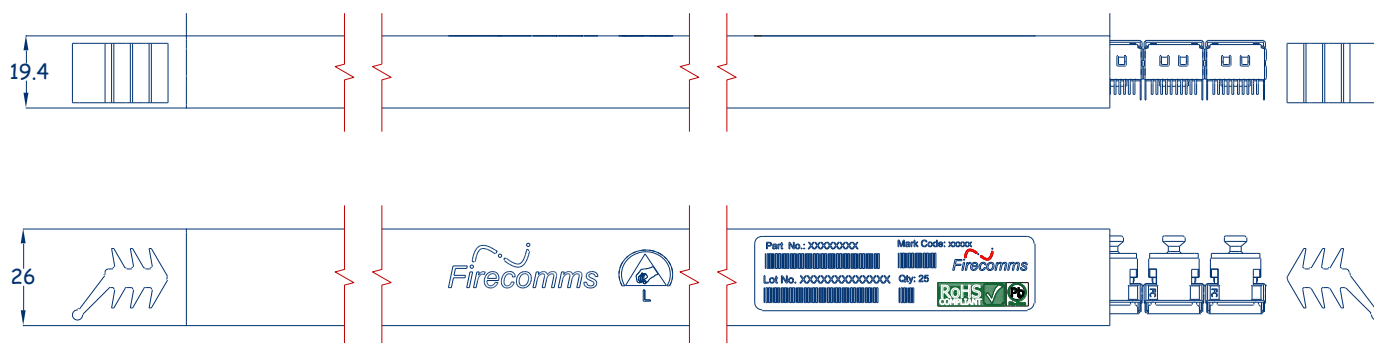


FIGURE 14
Packing tube for Firecomms SMI Transceivers

PART HANDLING

Firecomms SMI transceivers are tested for handling in static-controlled assembly processes (HBM). Cleaning, degreasing and post solder washing should be carried out using standard solutions compatible with both plastics and the environment. For example, recommended solutions for degreasing are alcohols (methyl, isopropyl and isobutyl). Acetone, ethyl acetate, phenol or similar solution-based products are not permitted.

In the soldering process, non-halogenated water-soluble fluxes are recommended. Firecomms SMI transceivers are not suitable for use in reflow solder processes (infrared/vapor-phase reflow). The dust plug should remain in place during soldering, washing and drying processes to avoid contamination of the active optical area of each connector.

The Moisture Sensitivity Level (MSL) classification of this device is 2a according to JEDEC J-STD-020. The shelf life of an unopened MBB (Moisture Barrier Bag) is 24 months at < 40 °C and < 90 % R.H. Once the Moisture Barrier Bag is opened the devices can be either:

- a) Stored in normal factory conditions < 30 °C and < 60 % R.H. for a maximum of 672 hours (4 Weeks) prior to soldering
- b) Stored at < 10 % R.H. (Dry Cabinet)

PACKING INFORMATION

Components are packed in PVC anti-static tubes and in moisture barrier bags. Bags should be opened only in static-controlled locations, and standard procedures should be followed for handling moisture sensitive components.

Components per Tube	25
Tube Length	444 mm
Tube Width	26 mm
Tube Height	19.4 mm
Tubes per Bag	10
Bags per Inner Carton	1
Inner Carton Length	588 mm
Inner Carton Width	147 mm
Inner Carton Height	84 mm
Weight per Inner Carton, Complete	1.80 kg
Components per Inner Carton	250
Inner Cartons per Outer Carton	4
Outer Carton Length	600 mm
Outer Carton Width	310 mm
Outer Carton Height	195 mm
Weight per Outer Carton, Complete	7.53 kg
Components per Outer Carton	1000

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